

Features

- 100% EAS Guaranteed
- Green Device Available
- Super Low $R_{DS(ON)}$
- Advanced high cell density SGT MOS Technology

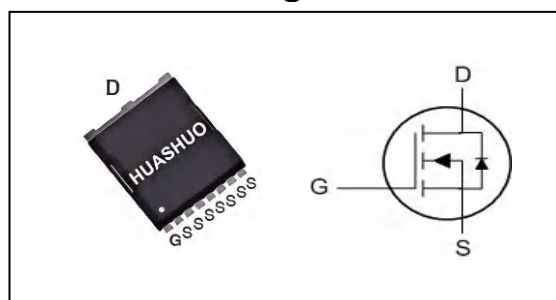
Product Summary

V_{DS}	100	V
$R_{DS(ON),max}$	1.9	m Ω
I_D	320	A

Applications

- MOTOR Driver
- UPS
- Power Tools
- Synchronous Rectification in SMPS

TOLL Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V ^{1,6}	320	A
$I_D@T_C=100^\circ\text{C}$	Continuous Drain Current, V_{GS} @ 10V ^{1,6}	224	A
I_{DM}	Pulsed Drain Current ²	1000	A
EAS	Single Pulse Avalanche Energy ³	850	mJ
I_{AS}	Avalanche Current	40	A
$P_D@T_C=25^\circ\text{C}$	Total Power Dissipation ⁴	333	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ¹	---	40	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	---	0.45	$^\circ\text{C/W}$

N-Ch 100V Fast Switching MOSFETs
Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V$, $I_D=250\mu A$	100	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance ²	$V_{GS}=10V$, $I_D=90A$	---	1.6	1.9	m Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=250\mu A$	2.0	2.9	4.0	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=80V$, $V_{GS}=0V$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=80V$, $V_{GS}=0V$, $T_J=125^\circ\text{C}$	---	---	100	
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V$, $V_{DS}=0V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V$, $I_D=20A$	---	75	---	S
Q_g	Total Gate Charge (10V)	$V_{DS}=50V$, $V_{GS}=10V$, $I_D=90A$	---	215	---	nC
Q_{gs}	Gate-Source Charge		---	58	---	
Q_{gd}	Gate-Drain Charge		---	52	---	
$T_d(on)$	Turn-On Delay Time	$V_{DD}=50V$, $V_{GS}=10V$, $R_G=3.0\Omega$, $I_D=20A$	---	47	---	ns
T_r	Rise Time		---	28	---	
$T_d(off)$	Turn-Off Delay Time		---	79	---	
T_f	Fall Time		---	18	---	
C_{iss}	Input Capacitance	$V_{DS}=50V$, $V_{GS}=0V$, $f=1\text{MHz}$	---	13370	---	pF
C_{oss}	Output Capacitance		---	1920	---	
C_{rss}	Reverse Transfer Capacitance		---	388	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current	---	---	100	A
V_{SD}	Diode Forward Voltage ²	$V_{GS}=0V$, $I_S=50A$, $T_J=25^\circ\text{C}$	---	---	1.1	V
t_{rr}	Reverse Recovery Time	$I_F=20A$, $dI/dt=100A/\mu s$, $T_J=25^\circ\text{C}$	---	70	---	nS
Q_{rr}	Reverse Recovery Charge		---	580	---	nC

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DD}=25V$, $V_{GS}=10V$, $L=0.1mH$, $I_{AS}=40A$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.
- 6.Package limitation current.

Typical Characteristics

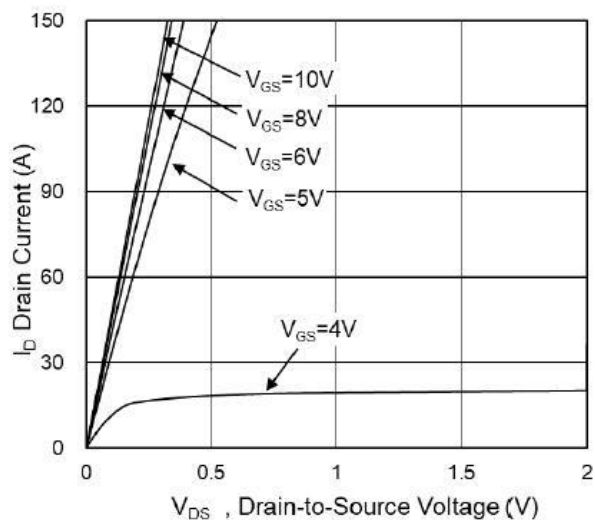


Fig.1 Typical Output Characteristics

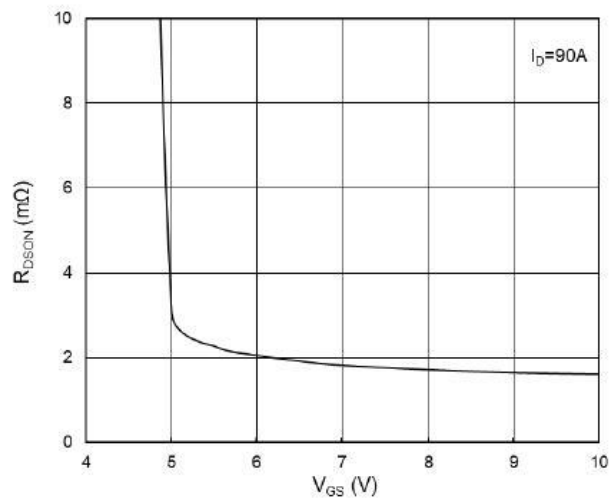


Fig.2 On-Resistance vs G-S Voltage

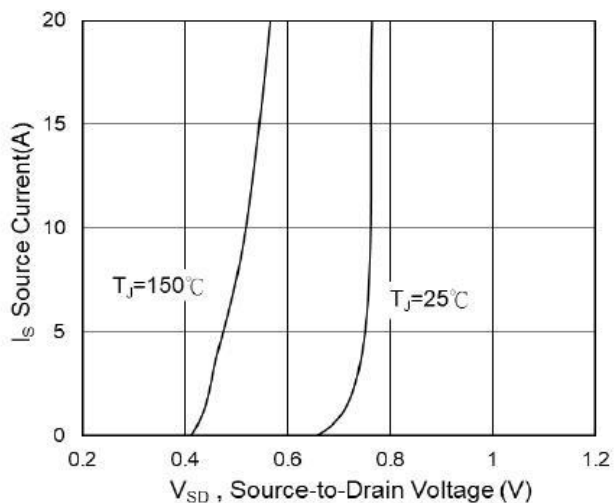


Fig.3 Source Drain Forward Characteristics

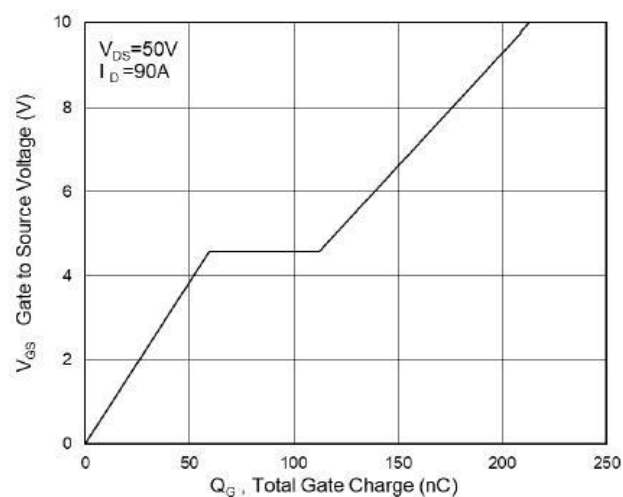


Fig.4 Gate-Charge Characteristics

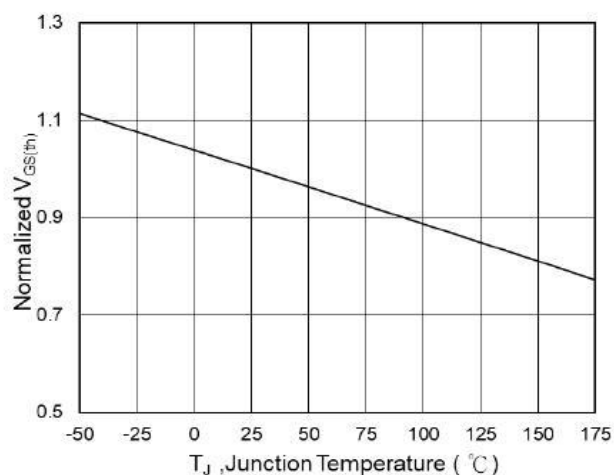


Fig.5 Normalized V_{TH} vs T_J

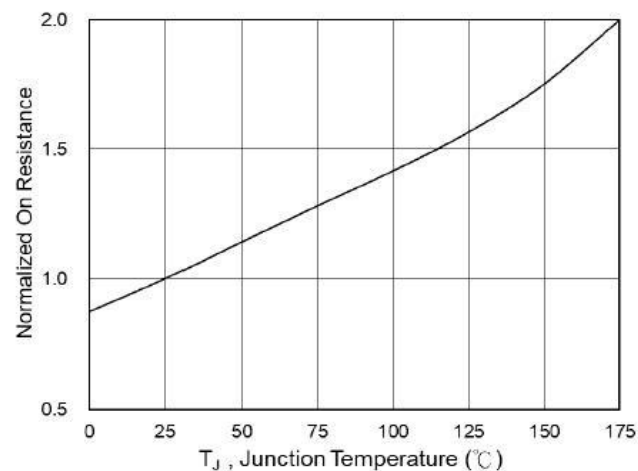


Fig.6 Normalized $R_{DS(on)}$ vs T_J

N-Ch 100V Fast Switching MOSFETs

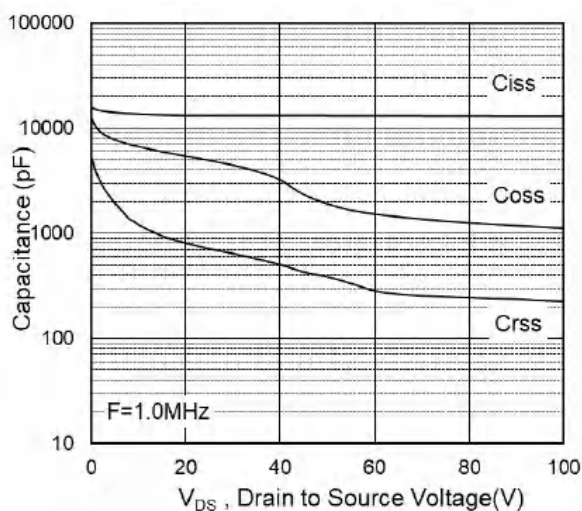


Fig.7 Capacitance

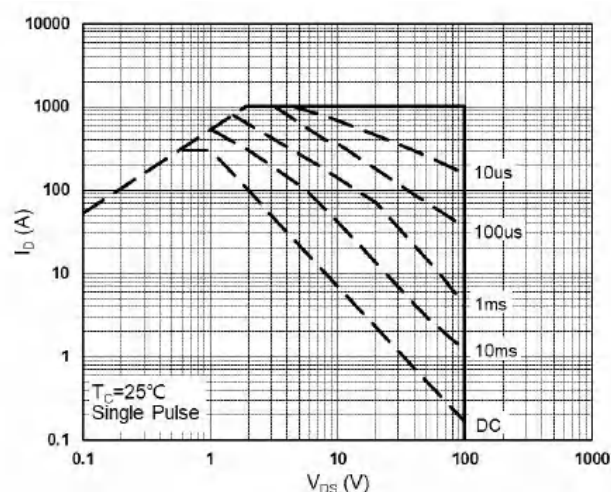


Fig.8 Safe Operating Area

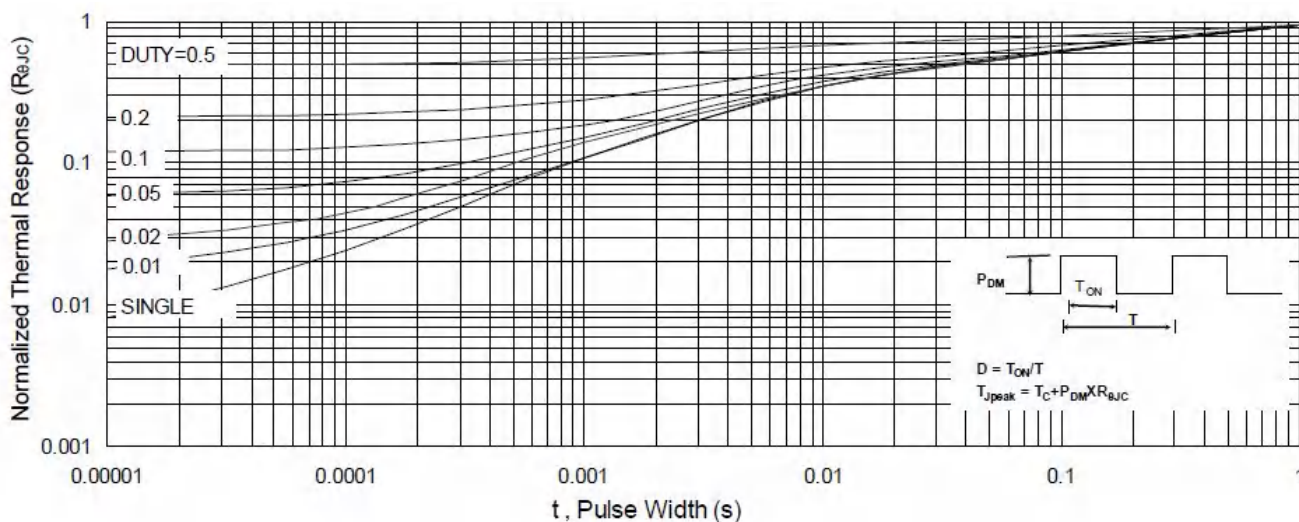


Fig.9 Normalized Maximum Transient Thermal Impedance

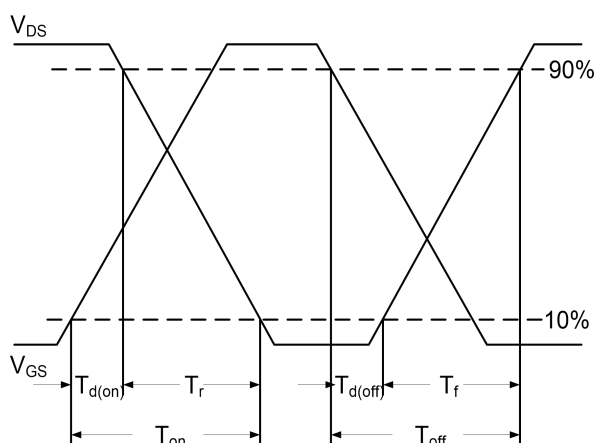


Fig.10 Switching Time Waveform

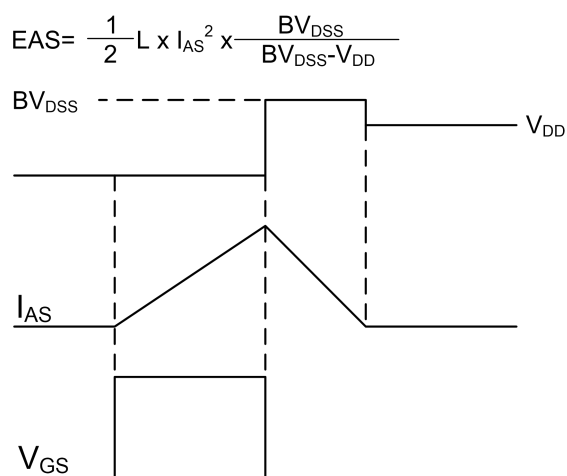
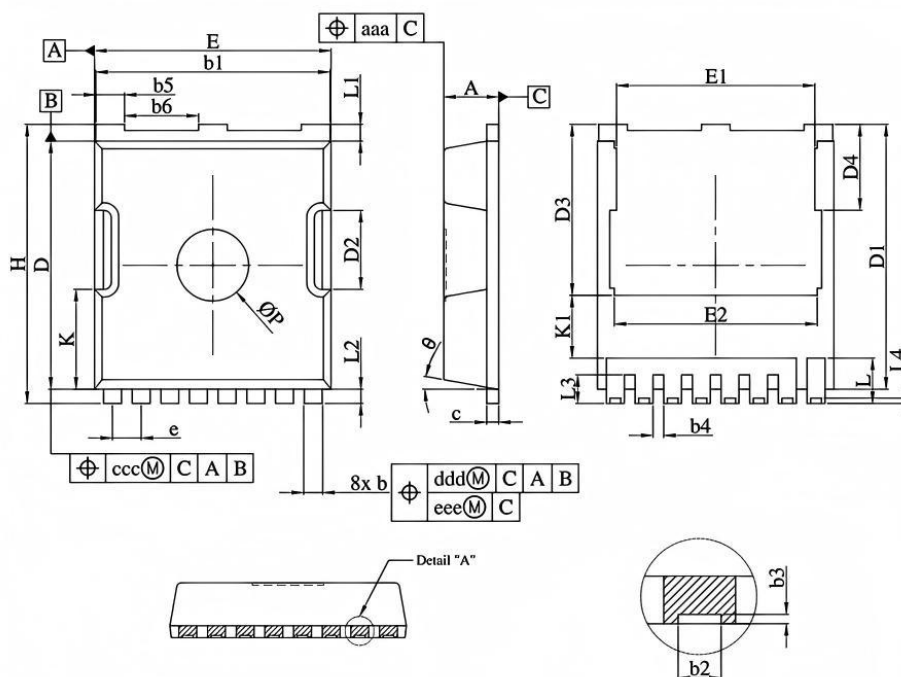


Fig.11 Unclamped Inductive Switching Waveform

Ordering Information

Part Number	Package code	Packaging
HSY0076A	TOLL	2000/Tape&Reel

TOLL Package Outline



COMMON DIMENSIONS(MM)							
SYMBOL	MIN.	NOMINAL	MAX.	SYMBOL	MIN.	NOMINAL	MAX.
A	2.20	2.30	2.40	E1	8.20	8.30	8.40
b	0.70	0.80	0.90	E2	8.35	8.50	8.65
b1	9.70	9.80	9.90	H	11.50	11.68	11.85
b2	0.36	0.45	0.55	K	4.08	4.18	4.28
b3	0.05	0.100	0.35	K1	2.45	---	---
b4	0.30	0.40	0.50	L	1.60	1.90	2.10
b5	1.10	1.20	1.30	L1	0.50	0.70	0.90
b6	3.00	3.10	3.20	L2	0.50	0.60	0.70
C	0.40	0.50	0.60	L3	1.00	1.20	1.30
D	10.28	10.38	10.55	L4	0.13	0.23	0.33
D1	10.98	11.08	11.18	P	2.85	3.00	3.15
D2	3.20	3.30	3.40	θ	10°REF		
D3	7.00	7.15	7.30	aaa	0.20		
D4	3.44	3.59	3.74	ccC	0.20		
e	1.10	1.20	1.30	ddd	0.25		
E	9.80	9.90	10.00	eee	0.20		

HSY0076A Marking:

